19-2550; Rev 2; 3/07

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

General Description

The MAX1946 single current-limited switch with autoreset supplies a guaranteed 500mA load in accordance with USB specifications. The MAX1946 operates from a 2.7V to 5.5V input supply and consumes only 40µA of quiescent current when operating and only 3µA in shutdown. Selectable active-high/active-low control logic and shutdown control provide additional flexibility. An autoreset feature latches the switch off in the event of a short circuit, saving system power. The switch reactivates upon removal of the shorted condition.

The MAX1946 provides several safety features to protect the USB port. Built-in thermal-overload protection turns off the switch when the die temperature exceeds +160°C. Accurate internal current-limiting circuitry protects the input supply against both overload and short-circuit conditions. An open-drain fault signal, ($\overline{FAULT}$), notifies the microprocessor (µP) when a thermal overload, current-limit, undervoltage lockout (UVLO), or short-circuit fault occurs. A 20ms fault-blanking feature enables the circuit to ignore momentary faults, such as those caused when hot-swapping a capacitive load, preventing false alarms to the host system. The fault-blanking feature prevents fault signals from being issued when the device powers up the load.

The MAX1946 is available in a space-saving 8-pin TDFN package and operates over the extended (-40°C to +85°C) temperature range.

Applications

USB Ports and USB Hubs

Notebook and Desktop Computers

PDAs and Palmtop Computers

Digital Cameras

Docking Stations

Features

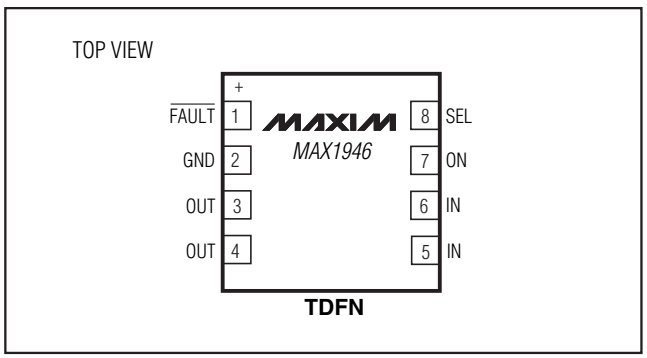
- ♦ **Single USB Switch in 3mm x 3mm Package**
- ♦ **Autoreset Feature Saves System Power**
- ♦ **Guaranteed 500mA Load Current**
- ♦ **Built-In 20ms Fault-Blanking Circuitry**
- ♦ **Active-High or Active-Low Control Logic**
- ♦ **Fully Compliant to USB Specifications**
- ♦ **2.7V to 5.5V Input Voltage Range**
- ♦ **Fault-Indicator Output**
- ♦ **Thermal-Overload Protection**
- ♦ **UL Certification Pending**

Ordering Information

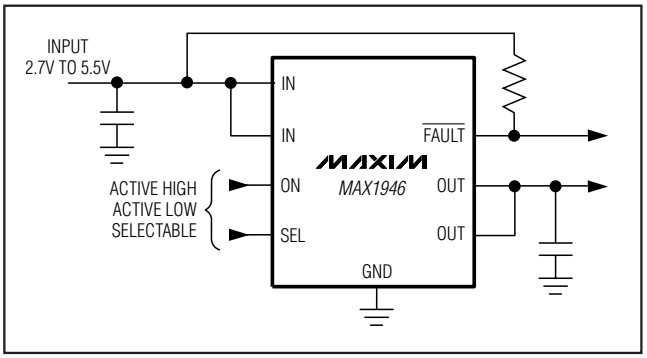
PART	TEMP RANGE	PIN-PACKAGE	TOP MARK	PKG CODE
MAX1946ETA+	-40°C to +85°C	8 TDFN-EP* 3mm x 3mm	ACQ	T833-1

+Denotes a lead-free package.
**EP = Exposed paddle.*

Pin Configuration



Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

ABSOLUTE MAXIMUM RATINGS

IN, ON, OUT, SEL to GND .....-0.3V to +6V
FAULT to GND .....-0.3V to (V_{IN} + 0.3V)
IN to OUT .....-0.3V to +6V
OUT Continuous Switch Current (internally limited) 1.3A
FAULT DC Current 10mA

Continuous Power Dissipation (T_A = +70°C)
Exposed Pad Must be Soldered to PC Board
8-Pin TDFN (derate 23.8mW/°C above +70°C) 1905mW
Operating Temperature Range .....-40°C to +85°C
Junction Temperature .....+150°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V_{IN}		2.7		5.5	V
Switch On-Resistance	R_{ON}	V_{IN} = 5, T_A = +25°C		75	90	mΩ
		V_{IN} = 5V			110	
		V_{IN} = 3.3V			125	
Standby Supply Current		Switch disabled		3	10	µA
Quiescent Supply Current	I_{IN}	Switch enabled, I_{OUT} = 0		40	60	µA
OUT Off-Leakage Current	I_{LKG}	Switch disabled, V_{OUT} = 0, T_A = +25°C		0.01	1	µA
		Switch disabled, V_{OUT} = 0, T_A = +85°C		0.2		
Undervoltage Lockout Threshold	V_{ULVO}	Rising edge, 3% hysteresis	2.3	2.5	2.7	V
Continuous Load Current			500			mA
Continuous Current Limit	I_{LIM}	$V_{IN_}$ - V_{OUT} = 0.5V	0.74	1.1	1.20	A
Short-Circuit Current Limit	I_{SC}	V_{OUT} = 0 (I_{OUT} pulsing)	0.8	1.2	1.6	A_{PK}
				0.35		A_{RMS}
Short-Circuit Detect Threshold		(Note 2)		1		V
Continuous Current-Limit Blanking Timeout Period		From continuous current-limit condition to FAULT asserted	10	20	35	ms
Short-Circuit Blanking Timeout Period		From short-circuit current-limit condition to FAULT asserted	7.5	18	35.0	ms
Turn-On Delay	t_{ON}	R_{OUT} = 10Ω, time from ON to 10% of V_{OUT}, does not include rise time	0.25	0.6	1.50	ms
Output Rise Time	t_{RISE}	R_{OUT} = 10Ω, from 10% to 90% of V_{OUT}		1.2		ms
Turn-Off Delay	t_{OFF}	R_{OUT} = 10Ω, time from ON to 90% of V_{OUT}, does not include fall time		0.8	2	ms
Output Fall Time	t_{FALL}	R_{OUT} = 10Ω, from 90% to 10% of V_{OUT}		3		ms
Thermal-Shutdown Threshold		15°C hysteresis		160		°C

ELECTRICAL CHARACTERISTICS (continued)

(V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, **T_A = 0°C to +85°C**, unless otherwise noted. Typical values are at T_A = +25°C.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ON, SEL Input High Level	V_{IH}	V_{IN} = 2.7V to 4V	1.6			V
		V_{IN} = 4V to 5.5V	2			
ON, SEL Input Low Level	V_{IL}	V_{IN} = 2.7V to 4V			0.6	V
		V_{IN} = 4V to 5.5V			0.8	
ON, SEL Input Leakage Current		V_{ON}, V_{SEL} = 0 or V_{IN}, T_A = +25°C	-1		+1	µA
$\overline{FAULT}$ Output Low Voltage	V_{OL}	I_{SINK} = 1mA, V_{IN} = 2.7V			0.5	V
$\overline{FAULT}$ Output High Leakage Current		V_{IN} = $V_{\overline{FAULT}}$ = 5.5V		1		µA
OUT Output Current Autoreset Mode		In latched off state, V_{OUT} = 0	10	25	45	mA
OUT Autoreset Threshold		In latched off state, V_{OUT} rising	0.4	0.5	0.6	V
OUT Autoreset Blanking Time		In latched off state, V_{OUT} > 0.5V	10	20	35	ms

ELECTRICAL CHARACTERISTICS

(V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, **T_A = -40°C to +85°C**, unless otherwise noted.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V_{IN}		2.7		5.5	V
Switch On-Resistance	R_{ON}	V_{IN} = 5, T_A = +25°C			90	mΩ
		V_{IN} = 5V			110	
		V_{IN} = 3.3V			125	
Standby Supply Current		Switch disabled			10	µA
Quiescent Supply Current	I_{IN}	Switch enabled, I_{OUT} = 0			60	µA
OUT Off-Leakage Current	I_{LKG}	Switch disabled, V_{OUT} = 0, T_A = -40°C to +25°C			1	µA
Undervoltage Lockout Threshold	V_{ULVO}	Rising edge, 3% hysteresis	2.3		2.7	V
Continuous Load Current			500			mA
Continuous Current Limit	I_{LIM}	$V_{IN_}$ - V_{OUT} = 0.5V	0.6		1.3	A
Short-Circuit Current Limit	I_{SC}	V_{OUT} = 0 (I_{OUT} pulsing)	0.8		1.6	A_{PK}
Continuous Current-Limit Blanking Timeout Period		From continuous current-limit condition to $\overline{FAULT}$ asserted	10		35	ms
Short-Circuit Blanking Timeout Period		From short-circuit current-limit condition to $\overline{FAULT}$ asserted	7.5		35.0	ms
Turn-On Delay	t_{ON}	R_{OUT} = 10Ω. Time from ON to 10% of V_{OUT}. Does not include rise time.	0.25		1.50	ms

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

ELECTRICAL CHARACTERISTICS (continued)

(V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, **T_A = -40°C to +85°C**, unless otherwise noted.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-Off Delay	t_{OFF}	R_{OUT} = 10Ω, time from ON to 90% of V_{OUT}, does not include fall time			2	ms
ON, SEL Input High Level	V_{IH}	V_{IN} = 2.7V to 4V	1.6			V
		V_{IN} = 4V to 5.5V	2			V
ON, SEL Input Low Level	V_{IL}	V_{IN} = 2.7V to 4V			0.6	V
		V_{IN} = 4V to 5.5V			0.8	V
ON, SEL Input Leakage Current		V_{ON}, V_{SEL} = 0 or V_{IN}	-1		+1	µA
$\overline{FAULT}$ Output Low Voltage	V_{OL}	I_{SINK} = 1mA, V_{IN} = 2.7V			0.5	V
OUT Output Current Autoreset Mode		In latched off state, V_{OUT} = 0	10		45	mA
OUT Autoreset Threshold		In latched off state, V_{OUT} rising	0.4		0.6	V
OUT Autoreset Blanking Time		In latched off state, V_{OUT} > 0.5V	10		35	ms

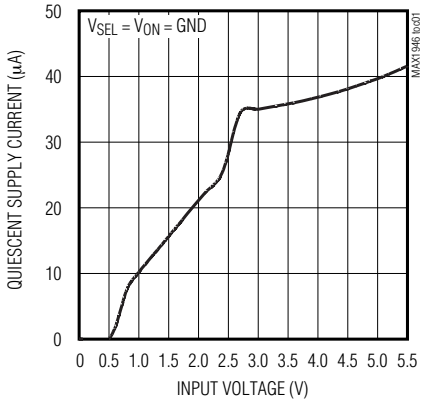
Note 1: All parts are 100% tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design.

Note 2: Short-circuit detect threshold is the output voltage at which the device transitions from short-circuit current limit to continuous current limit.

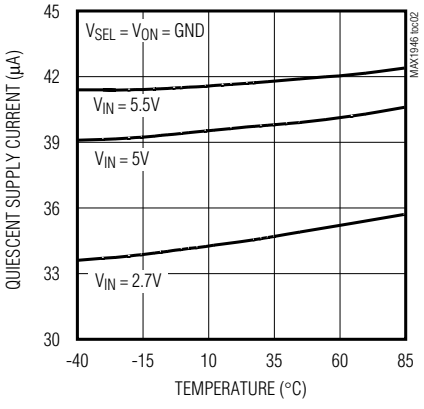
Typical Operating Characteristics

(Circuit of Figure 2, V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, ON = SEL, T_A = +25°C, unless otherwise noted.)

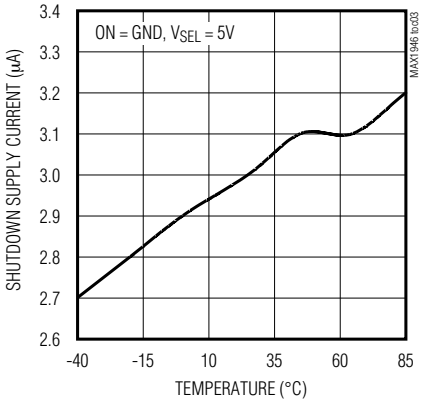
QUIESCENT SUPPLY CURRENT vs. INPUT VOLTAGE



QUIESCENT SUPPLY CURRENT vs. TEMPERATURE



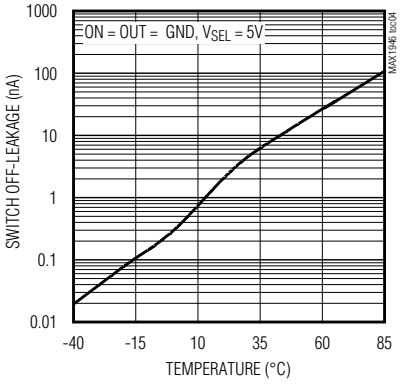
SHUTDOWN SUPPLY CURRENT vs. TEMPERATURE



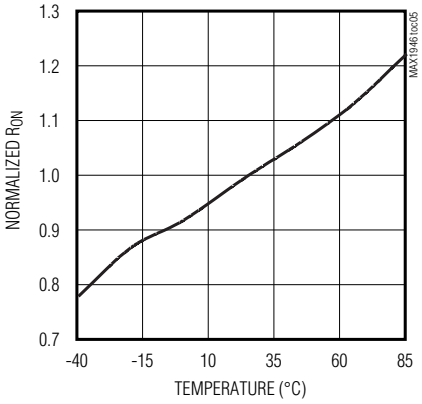
Typical Operating Characteristics (continued)

(Circuit of Figure 2, V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, ON = SEL, T_A = +25°C, unless otherwise noted.)

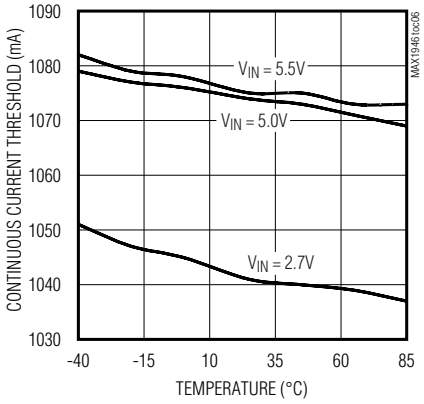
SWITCH OFF-LEAKAGE vs. TEMPERATURE



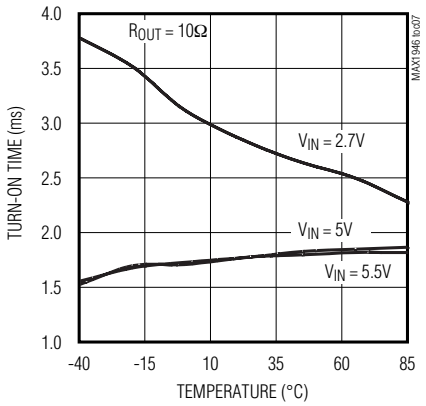
NORMALIZED ON-RESISTANCE vs. TEMPERATURE



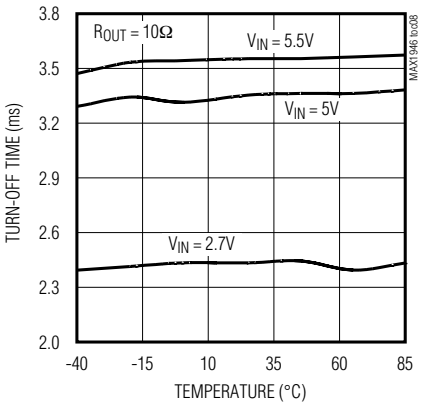
CONTINUOUS CURRENT-LIMIT THRESHOLD vs. TEMPERATURE



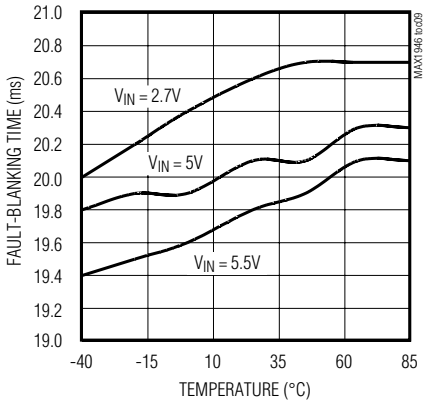
TURN-ON TIME vs. TEMPERATURE (t_{ON} + t_{RISE})



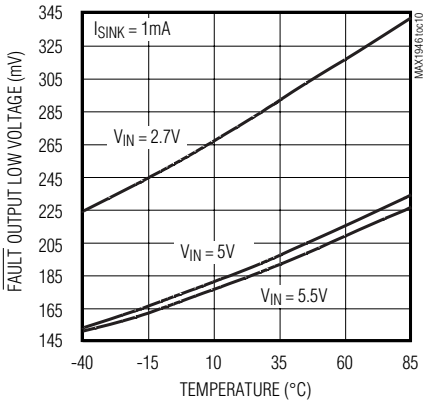
TURN-OFF TIME vs. TEMPERATURE (t_{OFF} + t_{FALL})



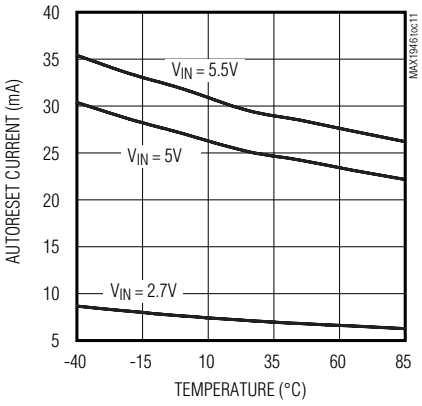
FAULT-BLANKING TIME vs. TEMPERATURE



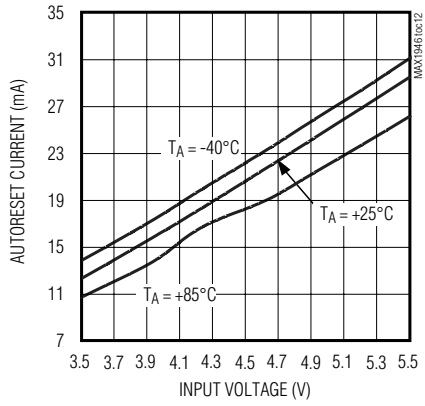
$\overline{FAULT}$ OUTPUT LOW VOLTAGE vs. TEMPERATURE



AUTORESET CURRENT vs. TEMPERATURE



AUTORESET CURRENT vs. INPUT VOLTAGE

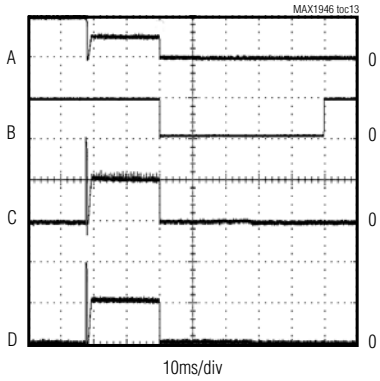


Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

Typical Operating Characteristics (continued)

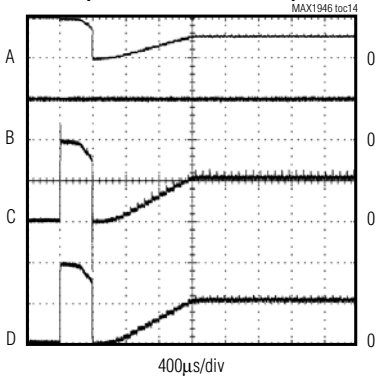
(Circuit of Figure 2, V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, ON = SEL, T_A = +25°C, unless otherwise noted.)

OVERLOAD RESPONSE INTO 2.5Ω



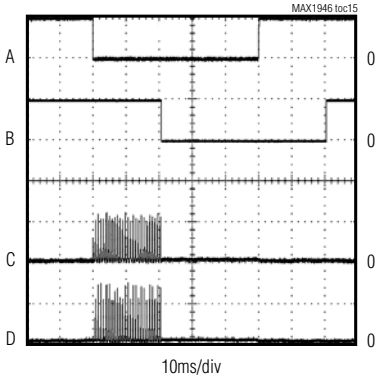
A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: I_{IN}, 1A/div
D: I_{OUT}, 1A/div

OVERLOAD RESPONSE INTO 2.5Ω (EXPANDED TIME SCALE)



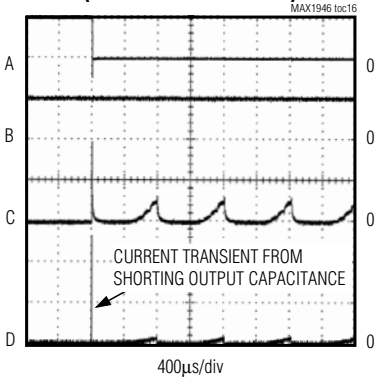
A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: I_{IN}, 1A/div
D: I_{OUT}, 1A/div

SHORT-CIRCUIT RESPONSE INTO 0Ω



A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: I_{IN}, 1A/div
D: I_{OUT}, 1A/div

SHORT-CIRCUIT RESPONSE INTO 0Ω (EXPANDED TIME SCALE)

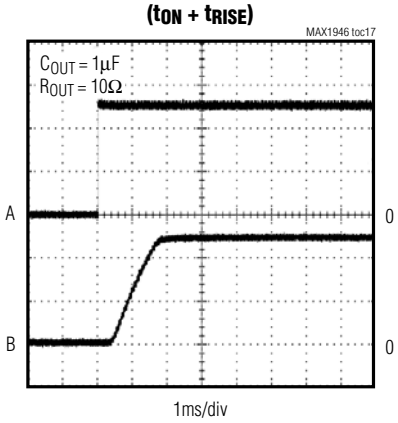


A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: I_{IN}, 2A/div
D: I_{OUT}, 10A/div

Typical Operating Characteristics (continued)

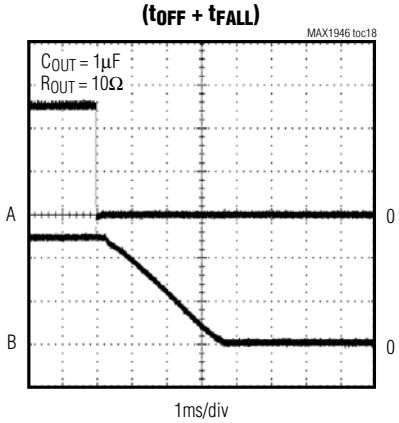
(Circuit of Figure 2, V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, ON = SEL, T_A = +25°C, unless otherwise noted.)

SWITCH TURN-ON TIME
(t_{ON} + t_{RISE})



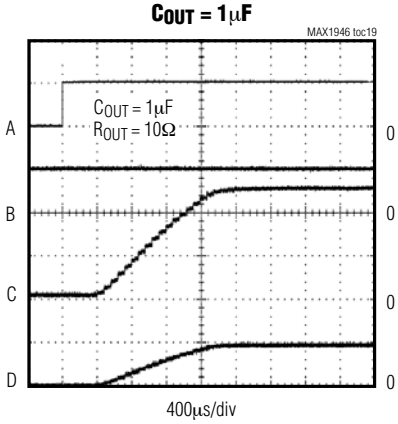
A: V_{ON}, 2V/div
B: V_{OUT}, 2V/div

SWITCH TURN-OFF TIME
(t_{OFF} + t_{FALL})



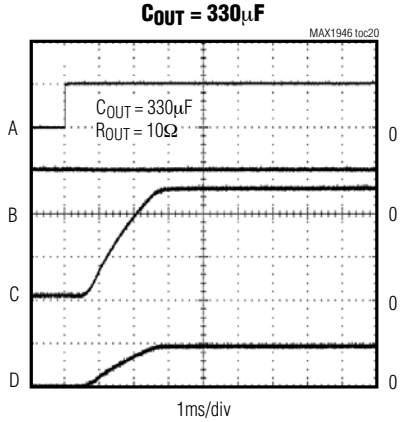
A: V_{ON}, 2V/div
B: V_{OUT}, 2V/div

STARTUP WAVEFORMS
C_{OUT} = 1µF



A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: V_{OUT}, 2V/div
D: I_{OUT}, 500mA/div

STARTUP WAVEFORMS
C_{OUT} = 330µF



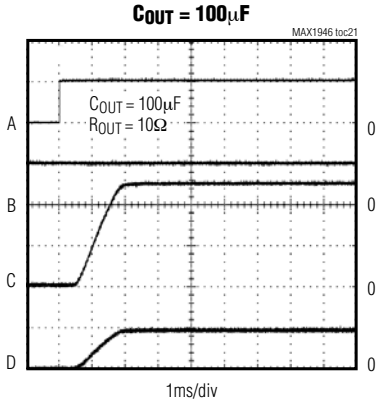
A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: V_{OUT}, 2V/div
D: I_{OUT}, 500mA/div

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

Typical Operating Characteristics (continued)

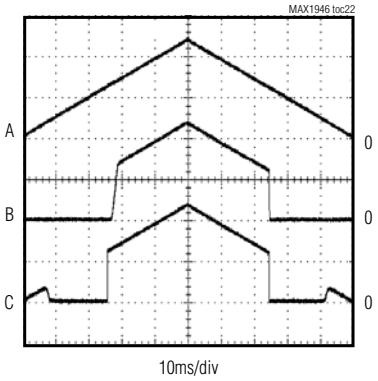
(Circuit of Figure 2, V_{IN} = 5V, C_{IN} = 0.1µF, C_{OUT} = 1µF, ON = SEL, T_A = +25°C, unless otherwise noted.)

STARTUP WAVEFORMS
C_{OUT} = 100µF



A: V_{OUT}, 5V/div
B: $V_{\overline{FAULT}}$, 5V/div
C: V_{OUT}, 2V/div
D: I_{OUT}, 500mA/div

UVLO RESPONSE



A: V_{IN}, 2V/div
B: V_{OUT}, 2V/div
C: $V_{\overline{FAULT}}$, 2V/div

Pin Description

PIN	NAME	FUNCTION
1	$\overline{FAULT}$	Fault-Indicator Output Switch. Open-drain output asserts low when switch enters thermal shutdown, undervoltage lockout, or a sustained (>20ms) current-limit or short-circuit condition.
2	GND	Ground
3, 4	OUT	Switch Power Output. Connect OUT pins together at the device and bypass with a 1µF ceramic capacitor. Load conditions may require additional bulk capacitance. When disabled, OUT goes into a high-impedance state.
5, 6	IN	Switch Power Input. Connect IN pins together at the device and bypass with a 0.1µF ceramic capacitor to GND. Input conditions may require additional bulk capacitance to prevent pulling the input supply down.
7	ON	ON/OFF Control Input. The active polarity of ON is set by SEL. Connect SEL high to make ON active high. Connect SEL to GND to make ON active low.
8	SEL	Logic Input Polarity Select. SEL sets the active polarity of the ON input. Connect SEL high to make ON active high. Connect SEL to GND to make ON active low.
—	EP	Exposed Metal Paddle. This paddle is internally connected to GND through a soft connect. For enhanced thermal dissipation, connect EP to a large ground plane. Do not use EP as a sole ground connection.

Detailed Description

The MAX1946 includes output current limiting, short-circuit protection, thermal shutdown, an enable input, and fault indicator (see the *Functional Diagram*). A logic input at SEL sets the active polarity of the enable input. The fault indicator notifies the system when the current-limit, short-circuit, undervoltage lockout, or thermal-shutdown threshold is exceeded.

The MAX1946 operates from a 2.7V to 5.5V input supply and supplies a minimum output current of 740mA. A built-in current limit of 1.1A limits the output current in the event of an overload condition. A built-in short-circuit detection circuit pulses the output current if the output voltage falls below 1V. This lowers RMS output current and reduces power dissipation during continuous short conditions.

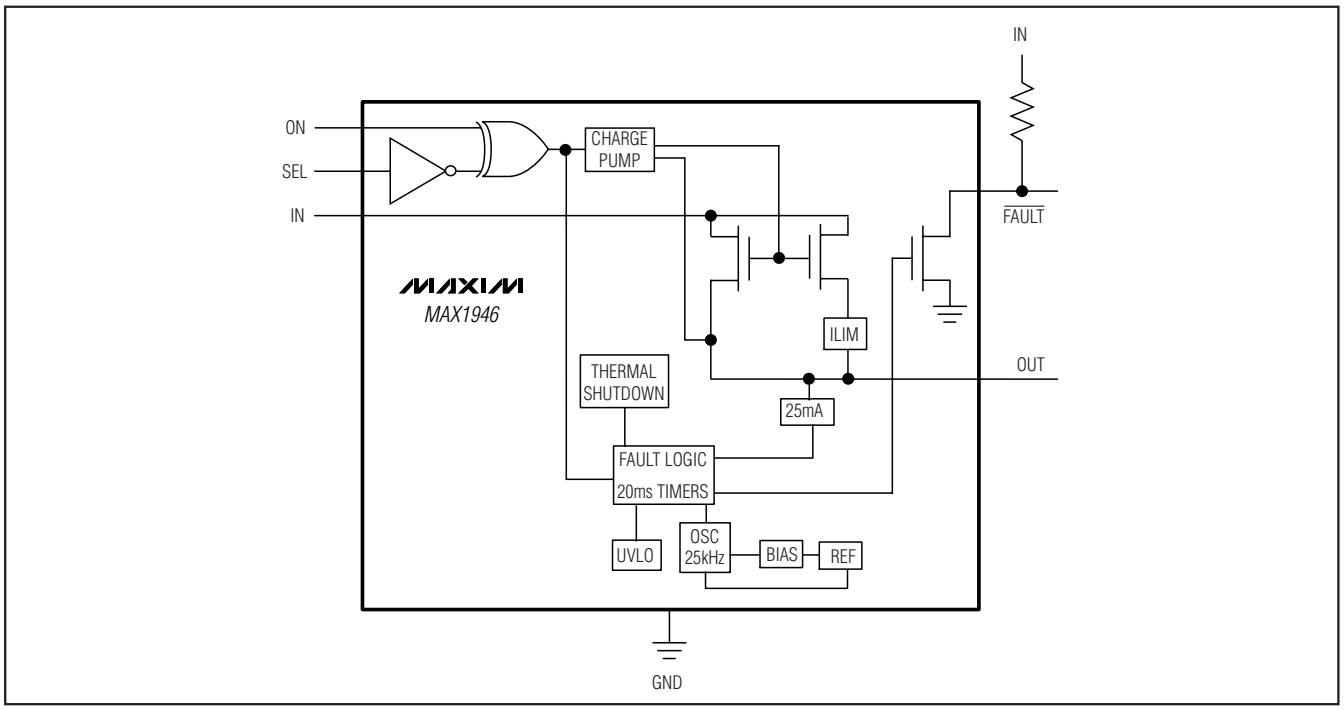


Figure 1. Functional Diagram

An internal micropower charge pump generates a high-side supply that drives the gate of an internal 75mΩ NMOS switch.

On/Off Control and Undervoltage Lockout (UVLO)

SEL sets the active polarity of the logic input of the MAX1946. Connect ON to the same voltage as SEL to enable OUT. Connect ON to the opposite voltage as SEL to disable OUT (see Table 1). The output enters a high-impedance state when disabled.

The MAX1946 includes a UVLO circuit to prevent erroneous switch operation when the input voltage goes low during startup and brownout conditions. Input voltages less than 2.5V inhibit operation of the device. $\overline{FAULT}$ asserts low during a UVLO condition.

Output Fault Protection and Autoreset

The MAX1946 senses the switch output voltage and selects continuous current limiting for V_{OUT} greater than 1V or short-circuit current limiting for V_{OUT} less than 1V. When V_{OUT} is greater than 1V, the device operates in a continuous current-limit mode that limits output current to 1.1A. When V_{OUT} is less than 1V, the device operates in short-circuit current-limit mode, sourcing 1.2A pulses to the load. When either fault condition persists for 20ms, the output turns off and the fault flag asserts. The output automatically restarts 20ms after the short or overload is removed.

The MAX1946 detects short-circuit removal by sourcing 25mA from the output and monitoring the output voltage. When the voltage at the output exceeds 0.5V for 20ms, the fault flag resets, the output turns back on, and the 25mA current source turns off.

Table 1. On/Off Control

SEL	ON	OUT BEHAVIOR
GND	GND	ON
	V_{IN}	OFF
V_{IN}	GND	OFF
	V_{IN}	ON

Thermal Shutdown

When the MAX1946 die temperature exceeds +160°C the switch turns off and $\overline{FAULT}$ goes low. Thermal shutdown does not utilize the 20ms fault-blanking timeout period. When the junction temperature cools by 15°C the switch turns on again and $\overline{FAULT}$ returns high.The switch cycles on and off if the overload condition persists, resulting in a pulsed output that reduces the average system load.

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

Fault Indicator

The MAX1946 provides an open-drain fault output, $\overline{FAULT}$. Connect $\overline{FAULT}$ to IN through a 100kΩ pullup resistor for most applications. $\overline{FAULT}$ asserts low when any of the following conditions occur:

- The input voltage is below the UVLO threshold.
- The switch junction temperature exceeds the +160°C thermal-shutdown temperature limit.
- The switch is in current-limit or short-circuit current-limit mode for more than 20ms.

The $\overline{FAULT}$ output deasserts after a 20ms delay once the fault condition is removed. Ensure that the MAX1946 input bypass capacitance is sufficiently large to prevent load glitches from triggering the $\overline{FAULT}$ output. Limit the input voltage slew rate to 0.2V/µs to prevent erroneous $\overline{FAULT}$ indications.

To differentiate large capacitive loads from short circuits or sustained overloads, the MAX1946 has a fault-blanking circuit. When a load transient causes the device to enter current limit, an internal counter monitors the duration of the fault. For load faults exceeding the 20ms fault-blanking time, the switch turns off, $\overline{FAULT}$ asserts low, and the device enters autoreset mode (see the *Output Fault Protection and Autoreset* section). Only current-limit and short-circuit faults are blanked. Thermal-overload faults and input voltage drops below the UVLO threshold immediately turn the switch off and assert $\overline{FAULT}$ low.

Fault blanking allows the MAX1946 to handle USB loads that may not be fully compliant with the USB specification. The MAX1946 successfully powers USB loads with additional bypass capacitance and/or large startup currents while protecting the upstream power source. No fault is reported if the switch brings up the load within the 20ms blanking period. See Table 2 for a summary of current limit and fault behavior.

Applications Information

Typical Application Circuit

Input Power Supply and Capacitance

Connect both IN inputs together. IN powers the internal control circuitry and charge pump for the switch. Bypass IN to GND with a 0.1µF ceramic capacitor. When driving inductive loads or operating from inductive sources, which may occur when the MAX1946 is powered by long leads or PC traces, larger input bypass capacitance is required to prevent voltage spikes from exceeding the MAX1946's absolute maximum ratings during short-circuit events.

Table 2. Current Limiting and Fault Behavior

CONDITION	MAX1946 BEHAVIOR
Output Short Circuit (V_{OUT} < 1V)	• If a short is detected at the output, the switch turns off, and the blanking timer begins. $\overline{FAULT}$ remains high during the blanking timeout period. • If the short persists during the fault-blanking period, the output pulses at $0.35A_{RMS}$. If the short is removed before the 18ms short-circuit blanking timeout period, the next ramped current pulse soft starts the output. $\overline{FAULT}$ remains high. • If the short circuit persists after the fault-blanking period, $\overline{FAULT}$ goes low, autoreset mode begins, and the output sources 25mA. • If the output voltage rises above 0.5V for 20ms, the switch resets, the output turns on, and $\overline{FAULT}$ goes high (see Short-Circuit Response in the *Typical Operating Characteristics*.)
Output Overload Current (V_{OUT} > 1V)	• Output current regulates at I_{LIM} and the blanking timer turns on. $\overline{FAULT}$ remains high during the blanking timeout period. • Continuous current at I_{LIM} persists until either the 20ms blanking period expires or a thermal fault occurs. • If overcurrent persists after 20ms, $\overline{FAULT}$ goes low, autoreset mode is enabled, and the output sources 25mA. • If the output voltage rises above 0.5V for 20ms, the switch resets, the output turns on, and $\overline{FAULT}$ goes high (see Short Overload Response in the *Typical Operating Characteristics*.)
Thermal Fault (T_J > +160°C)	• A junction temperature of +160°C immediately asserts $\overline{FAULT}$ low (the blanking timeout period does not apply for thermal faults) and turns off the switch. When the junction cools by 15°C, the thermal fault is cleared and $\overline{FAULT}$ goes high. Note that if other fault conditions are present when a thermal fault clears, those fault states then take effect.

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

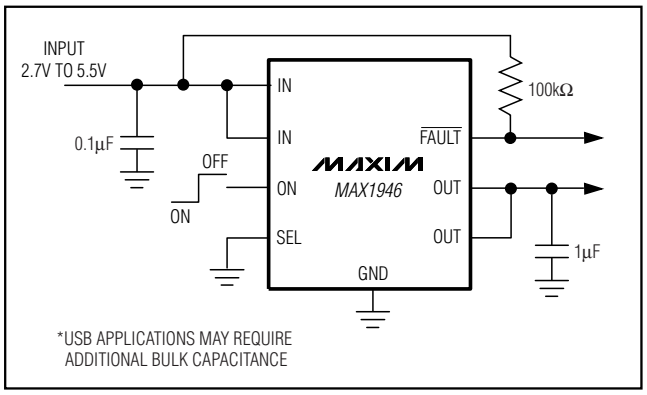


Figure 2. Typical Application Circuit

Output Capacitor

Bypass OUT to GND with a 1µF ceramic capacitor for local decoupling. Additional bulk capacitance (up to 470µF) reduces output-voltage transients under dynamic load conditions. Using output capacitors greater than 470µF can assert $\overline{FAULT}$ if the current limit cannot charge the output capacitor within the 20ms fault-blanking period. In addition to bulk capacitance, small-value (0.1µF or greater) ceramic capacitors improve the output's resilience to electrostatic discharge (ESD).

Driving Inductive Loads

A wide variety of devices (mice, keyboards, cameras, and printers) typically connect to the USB port with cables, which can add an inductive component to the load. This inductance causes the output voltage at the USB port to oscillate during a load step. The MAX1946 drives inductive loads, but avoid exceeding the device's absolute maximum ratings. The load inductance is usually relatively small, and the MAX1946 input typically includes substantial bulk capacitance from an upstream regulator as well as local bypass capacitors, limiting overshoot. If severe ringing occurs due to large load inductance, clamp the MAX1946 output below +6V and above -0.3V.

Turn-On and Turn-Off Behavior

When turned on, the MAX1946 output ramps up over 1.2ms to eliminate load transients on the upstream power source. When turned off, the output ramps down for 3ms. Under fault conditions, the output of the MAX1946 turns off rapidly to provide maximum safety for the upstream power source and downstream devices. Internal blocks shut down to minimize supply current when the switch is off.

Layout and Thermal Dissipation

Keep all traces as short as possible to reduce the effect of undesirable parasitic inductance, and to optimize the switch response time to output short-circuit conditions. Place input and output capacitors no more than 5mm from device leads. Connect IN and OUT to the power bus with short traces. The exposed pad on the TDFN package underside must be soldered to the PC board in order to realize the rated package dissipation.

An active switch dissipates little power with minimal change in package temperature. Calculate the power dissipation for this condition as follows:

$$P = (I_{OUT})^2 \times R_{ON}$$

At the normal operating current (I_{OUT} = 0.5A) and the maximum on-resistance of the switch (90mΩ), the power dissipation is:

$$P = (0.5A)^2 \times 0.09\Omega = 22.5mW$$

The worst-case power dissipation occurs when the output current is just below the current-limit threshold (1.2A max) with an output voltage just greater than 1V. In this case, the power dissipated is the voltage drop across the switch multiplied by the current limit:

$$P = I_{LIM} \times (V_{IN} - V_{OUT})$$

For a 5V input and 1V output, the maximum power dissipation per switch is:

$$P = 1.2A \times (5V - 1V) = 4.8W$$

Since the package power dissipation is 1951mW for the 8-pin TDFN, the MAX1946 die temperature exceeds the +160°C thermal-shutdown threshold. The switch output shuts down until the junction temperature cools by 15°C. The duty cycle and period are strong functions of the ambient temperature and the PC board layout (see the *Thermal Shutdown* section).

If the output current exceeds the current-limit threshold, or the output voltage is pulled below the short-circuit detect threshold, the MAX1946 enters a fault state after 20ms, at which point autoreset mode is enabled and 25mA is sourced by the output. For a 5V input, OUT short-circuited to GND, and autoreset mode active, the power dissipation is as follows:

$$P = 0.025A \times 5V = 0.125W$$

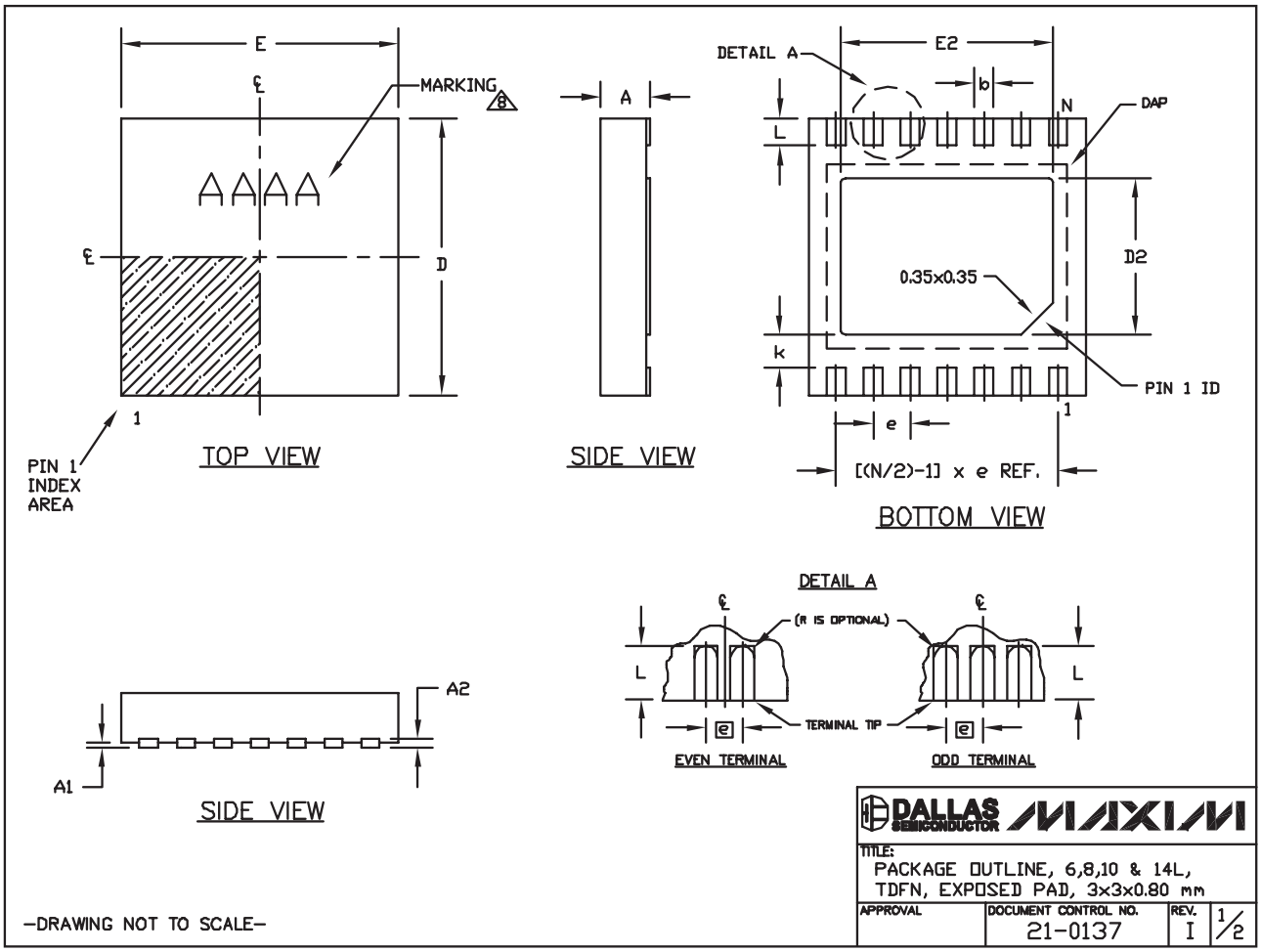
Chip Information

PROCESS: BiCMOS

Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.



Single USB Switch with Autoreset and Fault Blanking in Tiny TDFN

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	2/2

Revision History

Pages changed at Rev 2: 1–13

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